BGA Heat Sink - High Performance Straight Fin w/maxiGRIP





ATS Part#: ATS-53330R-C1-R0

Description: 33.00 x 33.00 x 19.50 mm BGA Heat Sink - High Performance Straight Fin

w/maxiGRIP

Heat Sink Type: Straight Fin
Heat Sink Attachment: maxiGRIP

Equivalent Part Number: ATS-53330R-C2-R0 Discontinued

*Image above is for illustration purpose only.

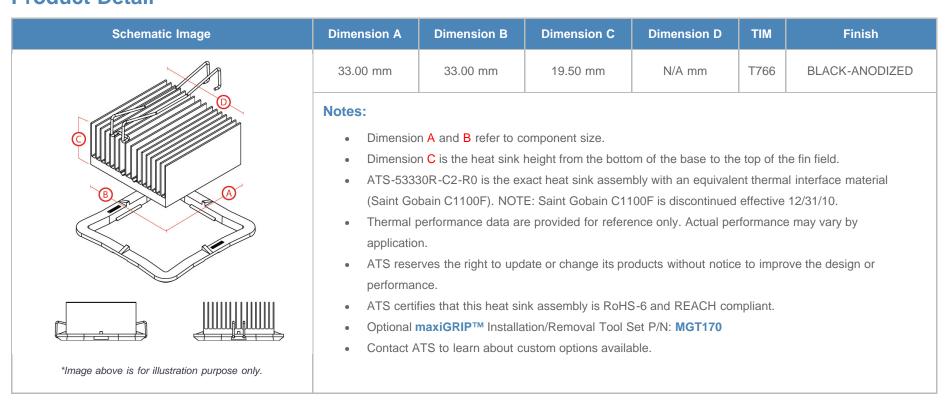
Features & Benefits

- · High aspect ratio, straight fin heat sinks that are ideal for compact PCB environments
- maxiGRIP™ attachment applies steady, even pressure to the component and does not require holes in the PCB
- Designed specifically for BGAs and other surface mount packages
- Meets Telcordia GR-63-Core Office Vibration; ETSI 300 019 Transportation Vibration; and MIL-STD-810 Shock Testing and Unpackaged Drop Testing standards
- Comes preassembled with high performance, phase changing, thermal interface material

Thermal Performance

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	4.1 °C/W	3 °C/W	2.6 °C/W	2.3 °C/W	2.1 °C/W	2 °C/W	1.8 °C/W
	Ducted Flow	2.3	N/A	N/A	N/A	N/A	N/A	N/A

Product Detail





Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Advanced Thermal Solutions:

ATS-53330R-C1-R0